



TASK-3I170DW

Fanless Embedded Computer with
6th / 7th Gen Intel® Skylake-S /
Kaby Lake-S i7 / i5 / i3 processor

Features:

- 6th / 7th Gen Intel® Skylake-S / Kaby Lake-S i7 / i5 / i3 CPU
- Intel® Q170 Chipset
- 1 x DDR4 SODIMM socket, Max. 32GB
- Multiple Independent display: VGA & HDMI
- 5 x Intel GbE LAN, 2 x USB 3.0, 2 x USB 2.0, 2 x COM
- 2 x Mini PCIe, 1 x SIM

Specifications :

Motherboard	3I170DW	
CPU	6th / 7th Gen Intel® Skylake-S / Kaby Lake-S i7 / i5 / i3 CPU	
Chipset	Intel® Q170	
Memory	1 x DDR4 SODIMM socket, Max. 32GB	
Storage	mSATA, HDD / SSD*	
Expansion slots	1 x Full-size Mini PCIe (PCIe / mSATA / USB) 1 x Half-size Mini PCIe (PCIe / mSATA / USB) 1 x SIM	
I/O ports	Network	5 x Intel GbE
	USB	2 x USB 3.0, 2 x USB 2.0
	Serial ports	2 x RS232 / 422 / 485
	Display	1 x VGA, 1 x HDMI
	GPIO	DI / DO (Option)
	Audio	Line-out / Mic-in (OEM)
Optional Modules & Accessory	GPS, Bluetooth, PoE, WiFi, 4G LTE, Isolated COM, battery UPS, DI/DO, Video Input *SATA Kit, VESA Mounting Kit	
OS Support	7th Generation Intel® Core™ Processor family: Kaby Lake Windows® 10 IOT (64bit), Ubuntu 16.04.3 above, Fedora 26 above, CentOS 7.4 above 6th Generation Intel® Core™ Processor family: Skylake Windows® 10 IOT (64bit) Windows® 8.1 (64bit) Windows® Embedded 8 Standard (64bit) Windows® 7 (64bit) Windows® Embedded Sta 7 (64bit) Ubuntu 16.04.3 above, Fedora 26 above, CentOS 7.4 above	

Mechanical

Dimensions	210W x 125D x 77H mm
Weight	1.9 kg
Mounting	VESA Mount*

Power

DC input	+9~36V
AC input	External adapter 100 / 240V ; AC-DC 84W

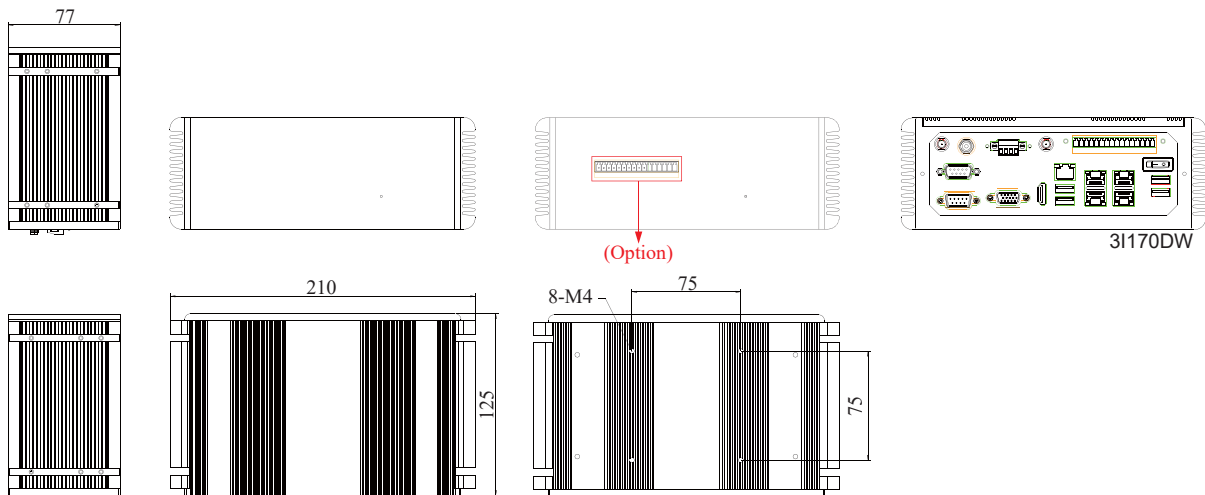
Environment

Operating Temp. (100 % CPU usage)	-20°C to +50°C (Core i7 6700 TE) *W / Industrial SSD
Storage Temp.	-20°C to +70°C
Relative Humidity	95% @ 40°C, non-condensing

Certification

CE / FCC class A

Dimension



Specification are subject to change without prior notice. ODM / OEM is available.